

## Part Number 601964 9X14 mm SMD, **3.3V, CMOS VCXO**

Frequency: Frequency Pulling: Temperature Range: Storage:

Input Voltage:
Input Current:
Control Voltage:
Output:

Symmetry: Rise/Fall Time:

Linearity: Logic: Load:

Output Current: 12KHz to 80MHz:

Phase Noise Floor:

Sub-Harmonics: Aging:

100.000 MHz ±20ppm APR Min 0°C to 70°C -55°C to 120°C 3.3V ± 0.3V

15mA Typ, 25mA Max +1.65VDC ±1.65V

CMOS

45/55% Max @ 50% Vdd

3ns Max ±10% Max "0" = 10% \

"0" = 10% Vdd Max "1" = 90% Vdd Min

15pF 24mA Max

0.5psec Typ, 1psec RMS Max

-160dBc Typ,

-155dBc Max Guaranteed

None

<3ppm 1st/yr,

<1ppm every year thereafter





## Mechanical:

Shock: MIL-STD-883, Method 2002, Condition B

Solderability: MIL-STD-883, Method 2003

Vibration: MIL-STD-883, Method 2007, Condition A

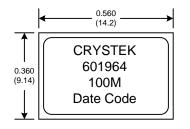
Solvent Resistance: MIL-STD-202, Method 215

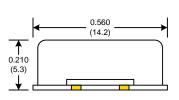
Resistance to Soldering Heat: MIL-STD-202, Method 210, Condition I or J

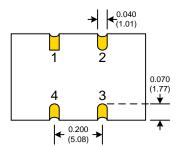
## **Environmental:**

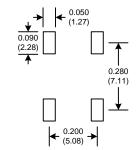
Thermal Shock: MIL-STD-883, Method 1011, Condition A

Moisture Resistance: MIL-STD-883, Method 1004

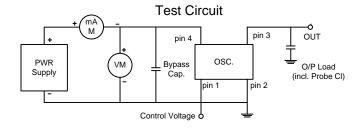






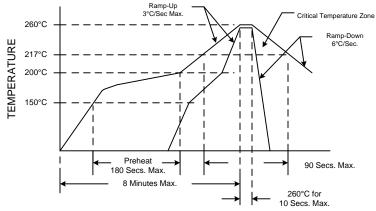


SUGGESTED PAD LAYOUT



PIN	Function
1	Control Volt
2	GND
3	OUT
4	Vcc

## RECOMMENDED REFLOW SOLDERING PROFILE



NOTE: Reflow Profile with 240°C peak also acceptable.

PN:601964 Rev. B

